



**DXT651** 

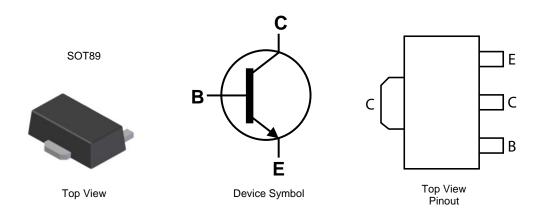
#### 60V NPN LOW VCE(sat) TRANSISTOR IN SOT89

#### **Features**

- BV<sub>CEO</sub> > 60V
- I<sub>C</sub> = 3A high Continuous Current
- Low saturation voltage V<sub>CE(sat)</sub> < 300mV @ 1A</li>
- Complementary PNP Type: DXT751
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT89
- Case material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 <sup>3</sup>
- Weight: 0.052 grams (Approximate)



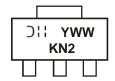
## **Ordering Information** (Note 4)

| Product    | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|------------|---------|--------------------|-----------------|-------------------|
| DXT651-13  | KN2     | 13                 | 12              | 2,500             |
| DXT651-13R | KN2     | 13                 | 12              | 4,000             |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



KN2 = Product Type Marking Code

Oli = Manufacturer's Marking Code

YWW = Date Code Marking

Y = Last digit of year (ex: 7 = 2007)

WW = Week code (01 - 53)



## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

| Characteristic               | Symbol           | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage       | $V_{CBO}$        | 80    | V    |
| Collector-Emitter Voltage    | V <sub>CEO</sub> | 60    | V    |
| Emitter-Base Voltage         | $V_{EBO}$        | 5     | V    |
| Collector Current            | Ic               | 3     | A    |
| Peak Pulse Collector Current | I <sub>CM</sub>  | 6     | А    |
| Base Current                 | I <sub>B</sub>   | 500   | mA   |

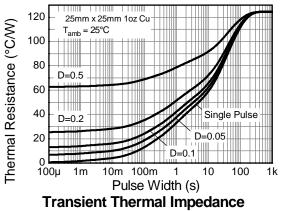
### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

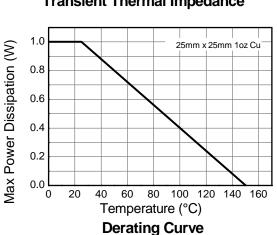
| Characteristic                                       | Symbol                            | Value       | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 5)                           | P <sub>D</sub>                    | 1           | W    |
| Thermal Resistance, Junction to Ambient Air (Note 5) | $R_{\theta JA}$                   | 125         | °C/W |
| Thermal Resistance, Junction to Leads (Note 6)       | $R_{	heta JL}$                    | 18.2        | °C/W |
| Operating and Storage Temperature Range              | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

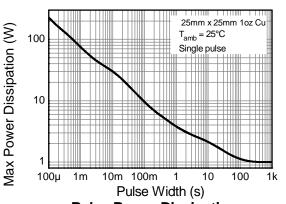
Notes:

- 5. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Thermal resistance from junction to solder-point (on the exposed collector pad).

## **Thermal Characteristics and Derating Information**







**Pulse Power Dissipation** 



## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                       | Symbol                              | Min                   | Тур                      | Max           | Unit     | Test Conditions  |
|--------------------------------------|-------------------------------------|-----------------------|--------------------------|---------------|----------|--|
| OFF CHARACTERISTICS (Note 7)         |                                     |                       |                          |               |          |  |
| Collector-Base Breakdown Voltage     | BV <sub>CBO</sub>                   | 80                    | _                        | _             | V        | $I_C = 100 \mu A, I_E = 0$   |
| Collector-Emitter Breakdown Voltage  | BV <sub>CEO</sub>                   | 60                    | _                        | _             | V        | $I_C = 10 \text{mA}, I_B = 0$  |
| Emitter-Base Breakdown Voltage       | BV <sub>EBO</sub>                   | 5                     | _                        | _             | V        | $I_E = 100 \mu A, I_C = 0$   |
| Collector-Base Cutoff Current        | I <sub>CBO</sub>                    | _                     | _                        | 0.1<br>10     | μΑ       | $V_{CB} = 60V, I_E = 0$<br>$V_{CB} = 60V, I_E = 0, T_A = +100$ °C  |
| Emitter-Base Cutoff Current          | I <sub>EBO</sub>                    | _                     | _                        | 0.1           | μA       | $V_{EB} = 4V, I_{C} = 0$   |
| ON CHARACTERISTICS (Note 7)          |                                     |                       |                          |               |          |  |
| Collector-Emitter Saturation Voltage | V <sub>CE(sat)</sub>                | _                     | 0.08<br>0.23             | 0.3<br>0.6    | V<br>V   | $I_C = 1A$ , $I_B = 100mA$<br>$I_C = 3A$ , $I_B = 300mA$   |
| Base-Emitter Saturation Voltage      | V <sub>BE(sat)</sub>                | _                     | 0.85                     | 1.25          | V        | $I_C = 1A$ , $I_B = 100mA$   |
| Base-Emitter Turn-On Voltage         | $V_{BE(on)}$                        | _                     | 0.8                      | 1             | V        | $V_{CE} = 2V, I_{C} = 1A$  |
| DC Current Gain                      | h <sub>FE</sub>                     | 70<br>100<br>80<br>40 | 200<br>200<br>185<br>120 | 300<br>—<br>— |          | $V_{CE} = 2V, I_{C} = 50mA$ $V_{CE} = 2V, I_{C} = 500mA$ $V_{CE} = 2V, I_{C} = 1A$ $V_{CE} = 2V, I_{C} = 2A$ |
| AC CHARACTERISTICS                   |                                     |                       |                          |               |          |  |
| Transition Frequency                 | f <sub>T</sub>                      | 140                   | 200                      | _             | MHz      | $V_{CE} = 5V$ , $I_{C} = 100$ mA, $f = 100$ MHz  |
| Output Capacitance                   | $C_{ m obo}$                        | _                     | _                        | 30            | pF       | $V_{CB} = 10V$ , $f = 1MHz$  |
| Switching Times                      | t <sub>on</sub><br>t <sub>off</sub> |                       | 35<br>230                |               | ns<br>ns | $V_{CC} = 10V$ . $I_C = 500mA$ ,<br>$I_{B1} = I_{B2} = 50mA$   |

Notes: 7. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

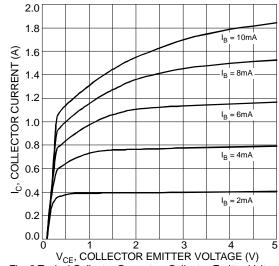
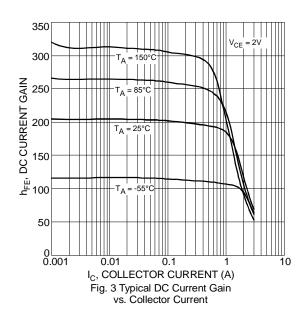
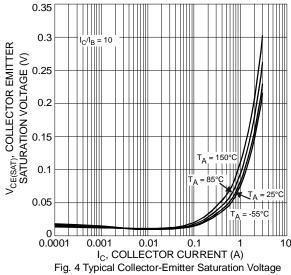


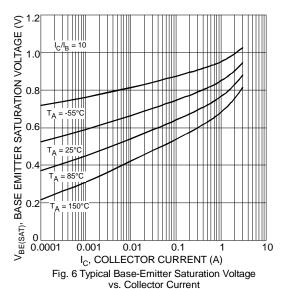
Fig. 2 Typical Collector Current vs.Collector-Emitter Voltage







vs. Collector Current



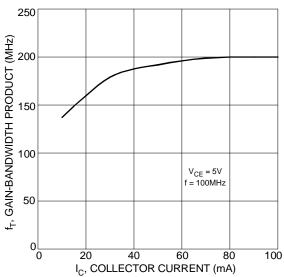


Fig. 8 Typical Gain-Bandwidth Product vs. Collector Current

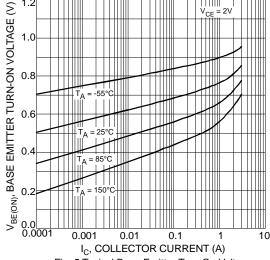


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current

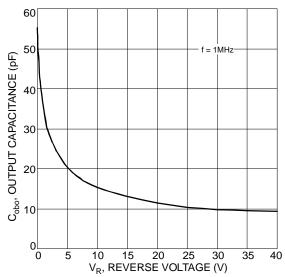
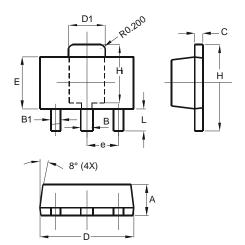


Fig. 7 Typical Output Capacitance Characteristics



# **Package Outline Dimensions**

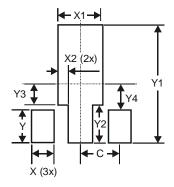
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SOT89 |                      |      |  |  |
|-------|----------------------|------|--|--|
| Dim   | Min                  | Max  |  |  |
| Α     | 1.40                 | 1.60 |  |  |
| В     | 0.44                 | 0.62 |  |  |
| B1    | 0.35                 | 0.54 |  |  |
| С     | 0.35                 | 0.44 |  |  |
| D     | 4.40                 | 4.60 |  |  |
| D1    | 1.62                 | 1.83 |  |  |
| Е     | 2.29                 | 2.60 |  |  |
| е     | 1.50 Typ             |      |  |  |
| Н     | 3.94                 | 4.25 |  |  |
| H1    | 2.63                 | 2.93 |  |  |
| L     | 0.89                 | 1.20 |  |  |
| All [ | All Dimensions in mm |      |  |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х          | 0.900         |
| X1         | 1.733         |
| X2         | 0.416         |
| Y          | 1.300         |
| Y1         | 4.600         |
| Y2         | 1.475         |
| Y3         | 0.950         |
| Y4         | 1.125         |
| C          | 1 500         |



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